RoHS Certificates of Compliance for Customer	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.
RoHS Directive 2011/65/EU and any future amendments, addendum and decisions	**Issue Date:** 29 October, 2026

Supplier Information

Company Name	Contact Name	Phone – Contact	Email – Contact
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Family Series	Part Number	Description	Cert. revision
FM1xxx	FM1301-9RG	POWER SUPPLY;;DC-DC CONVERTER	001

RoHS Material Composition Declaration	

RoHS Definition per Directive 2011/65/EU and 2015/863: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr(VI)), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) , Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP) and quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium (Cd)

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Customer acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph.

☐ 1 - Item does not contain RoHS restricted substances per the definition above

☐ 2 - Item contains RoHS restricted substances above the limits per the definition above and is not under exemption. Please specify:

- ☐ Bis(2-ethylhexyl) phthalate (DEHP). **Restricted from 22 July 2019 per Directive 2015/863**
- ☐ Butyl benzyl phthalate (BBP). **Restricted from 22 July 2019 per Directive 2015/863**
- ☐ Dibutyl phthalate (DBP). **Restricted from 22 July 2019 per Directive 2015/863**
- ☐ Diisobutyl phthalate (DIBP). **Restricted from 22 July 2019 per Directive 2015/863**
- ☐ Lead (Pb), Mercury (Hg), Cadmium (Cd), Hexavalent Chromium (Cr(VI)), Polybrominated Biphenyls (PBB) or Polybrominated Diphenyl Ethers (PBDE). **Restricted from 3 Jan 2013 per Directive 2011/65/EU (Non-compliant)**

☒ 3 - Item does not contain RoHS restricted substances per the definition above, except for selected exemptions identified below

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and select all applicable exemptions.

Exemption List from Directive 2011/65/EU - Annex III

☐ 6(a)-I Lead as an alloying element in steel for machining purposes containing up to 0,35 % lead by weight and in batch hot dip galvanised steel components containing up to 0,2 % lead by weight (*expires 30 June 2027*)
☐ 6(b)-I Lead as an alloying element in aluminium containing up to 0,4 % lead by weight, provided it stems from lead-bearing aluminium scrap recycling (*expires 30 March 2027*)
☐ 6(b)-II Lead as an alloying element in aluminium for machining purposes with a lead content up to 0,4 % by weight (*6(b) expires 30 March 2027*)
☐ 6(b)-III Lead as an alloying element in aluminium casting alloys containing up to 0,3% lead by weight provided it stems from lead-bearing aluminium scrap recycling *(expires 30 June 2027)*
☒ 6(c) Lead as an alloying element in copper containing up to 4% lead by weight. *(expires 30 June 2027)*
☒ 7(a) Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead) *(expires 30 June 2027)*
☐ 7(a)-I Lead in high melting temperature type solders (i.e., lead-based alloys containing 85% by weight or more lead)
for internal interconnections for attaching die, or other components along with a die in semiconductor assembly with steady state or transient/impulse currents of 0.1 A or greater or blocking voltages beyond 10 V, or die edge sizes larger than 0.3 mm x 0.3 mm *(expires 31 December 2027)*
☐ 7(a)-II Lead in high melting temperature type solders (i.e., lead-based alloys containing 85% by weight or more lead) for integral (meaning internal and external) connections of die attach in electrical and electronic components, if all the following conditions are met:
- the thermal conductivity of the cured/sintered die-attach material is >35W/(m*K),
- the electrical conductivity of the cured/sintered die-attach material is >4.7MS/m ,
- solidus melting temperature is higher than 260°C *(expires 31 December 2027)*
☐ 7(a)-III Lead in high melting temperature type solders (i.e., lead-based alloys containing 85% by weight or more lead) in first level solder joints (internal or integral connections - meaning internal and external) for manufacturing components so that subsequent mounting of electronic components onto subassemblies (i.e. modules, sub-circuit boards, substrates, or point-to-point soldering) with a secondary solder does not reflow the first level solder. This sub-entry excludes die attach applications and hermetic sealings *(expires 31 December 2027)*
☐7(a)-IV Lead in high melting temperature type solders (i.e., lead-based alloys containing 85% by weight or more lead) as a hermetic sealing material between:
1. a ceramic package or plug and a metal case,
2. component terminations and an internal sub-part *(expires 31 December 2027)*
☐ 7(a)-V Lead in high melting temperature type solders (i.e., lead-based alloys containing 85% by weight or more lead) as a hermetic sealing material between:
1. a ceramic package or plug and a metal case,
2. component terminations and an internal sub-part *(expires 31 December 2027)*

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and select all applicable exemptions.
☒ 7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors**,** e.g. piezoelectronic devices, or in a glass or ceramic matrix compound. *(expires 30 June 2027)* ☐ 7(c)-II Lead in dielectric ceramic in capacitors for a voltage of 125 V AC or 250 V DC or higher. *(expires 30 December 2027)* ☐ 7(c)-V Electrical and electronic components containing lead in a glass or glass matrix compound that fulfils any of the following functions: 1) for protection and electrical insulation in glass beads of high-voltage diodes and glass layers for wafers ; 2) for hermetic sealing between ceramic, metal and/or glass parts; 3) for bonding purposes in a process parameter window for < 500 °C combined with a viscosity of 1013.3 dPas (‘glass-transition temperature’); 4) for use as a resistive material such as ink, with a resistivity range from 1 ohm/square to 100 megohm/square, excluding trimmer potentiometers; 5) for use in chemically modified glass surfaces for microchannel plates (MCPs), channel electron multipliers (CEMs) and resistive glass products (RGPs). *(expires 30 December 2027)* ☐ 7(c)-VI Electrical and electronic components containing lead in a ceramic that fulfils any of the following functions: 1) for use in piezoelectric lead zirconium titanate (PZT) ceramics; 2) for providing ceramics with a positive temperature coefficient (PTC). *(expires 30 December 2027)*

If other exemptions are required to be reported please enter below:

Declaration Signature	
Supplier Signature	 29 October, 2026